Performance

Positioning accuracy	±10μm(6σ)
Printing accuracy	±18μm(6σ)
Cycle time	8.5 sec + Printing time
Product changeover time	3min or less
New product set-up time	10min or less

Board handling

-				
Max. Size (L x W)	510mm x 510mm			
Min. Size (L x W)	50mm x 50mm			
Thickness	0.4~6mm			
PCB thickness adjustment	Automatic			
PCB Max. Weight	5kg			
PCB edge clearance	3mm			
PCB bottom clearance	23mm			
PCB warpage	Max. 1% diagonally			
Clamping method	Auto retractable top clamp, motor controlled side clamp			
Support method	Magnetic support pins, bars, blocks, vacuum suction			
Conveyor direction	L to R, R to L, R to R, L to L (software control)			
Conveyor height	900 ± 40mm			
Conveyor speed (max.)	1,000mm/s			
Conveyor width adjustment	Automatic			

Optical system

—	
Field-of-View (FOV)	10mm x 8mm
Fiducial types	Circle, triangle, square, diamond, cross
Fiducial size	0.5~4.0mm
Vision methodology	Digital CCD camera look up & down
2D inspection	Max.100 windows (10mmx8mm) to inspect missing & insufficient

Printing parameters

Stencil frame size (L x W)	Adjustable, 470 x 370mm to 737 x 737mm	
Print gap	0~20mm	
Printing table adjustment range	X: ±10 mm, Y: ±10mm θ: ± 2°	
Print speed	10~200mm/s	
Squeegee pressure	0~10kg (program control)	
Cleaning system	Auto wet, dry, vacuum (Software select)	

Squeegee type

Metal squeegee	210mm, 280mm, 350mm, 420mm, 520mm
Rubber squeegee	210mm, 280mm, 350mm
Squeegee angle	Std. 60°

Facilities requirement

Power supply	Single-phase AC200V~240V 50/60Hz	
Power consumption	3kW	
Air supply	0.4 ~0.6MPa/cm²	
Air consumption	5L/min	
Dimension (excluding signal tower)	1,240 (L) x 1,560 (W) x 1,490 (H)	
Machine weight	1,200kg	

Operator interface

Hardware	LCD Monitor, Mouse & Keyboard			
Operating system (OS)	Windows 7			
Control method	Industrial PC controlled			
I/O Interface	SMEMA Standard			



*The monitor can be mounted on either the left or right side.



JUKI CORPORATION HEAD OFFICE



Solder Paste Printer

RP-2(HP)/RP-2(B)

High Precision Solder Paste Printer with excellent cost performance





*Please refer to the product specifications for details. JUKI Specifications and appearance may be changed without notice.

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JUKI SMT ASIA CO.,LTD.

Apr- 2021/Rev.01











High Precision Solder Paste Printer with excellent cost performance



Solder Paste Printer

Multi-function model RP-2(HP)

Basic model RP-2(B)

PCB size : 50×50 mm - 510×510 mm Cycle time: 8.5 sec+Printing time Positioning accuracy : $\pm 10 \mu m(6\sigma)$ Printing accuracy : $\pm 18 \mu m(6\sigma)$ Stencil frame size : 735 ×735 mm/t : 30 mm

Optimum-Paste Control (OPC) - Get ready for lights - out manufacturing

Auto solder paste replenishment system HP

The solder paste is automatically dispensed across the entire squeegee length, maintaining at 15 mm rolling diameter, adopting the common 500 grams' solder paste jar.

Completely eliminates the wastage of solder paste overflowing to the sides of squeegee.



Solder paste rolling diameter monitoring system

Tracing solder paste rolling diameter in real time and trigger the auto dispensing if it falls below 10 mm. Completely eliminate insufficient solder paste on stencil and keep the paste rolling speed within optimum range to achieve best printing result.



Quality Print Control (QPC) - Nothing is more important than a GOOD print

Stencil aperture inspection system



Using panel light installed at the top and CCD camera below to inspect stencil apertures.

It automatically detects the clogging of stencil apertures to eliminate poor quality stencil being used, ensure quality printing right from the start.

The Stencil lock & PCB clamper

The Stencil lock sucks the stencil firmly on both sides of the conveyor during printing cycle.

To eliminate stencil vibration by having firm contact with PCB. The PCB clamper is a combination of retractable top clamp and motor controlled side clamp, uniquely designed by GKG (patented).

With these standard features, all of today's available and challenging substrates can be securely clamped and print to the highest quality.

SPI Close-loop connection

With SPI close-loop system, machine will automatically adjust and correct the print deposits based on the feedback given with regards to poor printing quality. This will facilitate improved print quality and production efficiency, by forming a complete printing feedback system.

Specifications, Options (S: Standard, O: Option, N/A: Not Applicable)

Features	RP-2 (HP)	RP-2 (B)	Features	RP-2 (HP)	RP-2 (B)
Metal squeegee 210, 350 mm	S	S	Printing table vacuum system	S	S
Metal squeegee 280, 420, 520 mm	0	0	Auto paste dispensing (rear mounting)	S	N/A
Rubber squeegee 210, 280, 350 mm	0	0	Paste rolling diameter monitoring system	S	N/A
Stencil lock	S	S	Temperature humidity monitoring & display	S	N/A
Auto table adjustment for pcb thickness	S	S	Internal barcode scanner for pcb traceability	0	N/A
Support block hit prevention system	S	S	Hand held scanner	0	0
Stencil y-direction position memory	S	S	Stencil aperture inspection system	S	N/A
Support pins set	S	S	Spi closed-loop	0	0
Support blocks set	S	S	2D Inspection (Max. 100 point)	S	S





